TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74LCX574F, TC74LCX574FT, TC74LCX574FK

Low-Voltage Octal D-Type Flip-Flop with 5-V Tolerant Inputs and Outputs

The TC74LCX574 is a high-performance CMOS octal D-type flip-flop. Designed for use in 3.3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

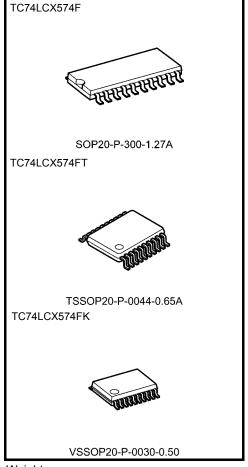
The device is designed for low-voltage (3.3 V) VCC applications, but it could be used to interface to 5 V supply environment for both inputs and outputs.

This 8-bit D-type flip-flop is controlled by a clock input (CK) and an output enable input ( $\overline{OE}$ ). When the  $\overline{OE}$  input is high, the eight outputs are in a high-impedance state.

All inputs are equipped with protection circuits against static discharge.

#### **Features**

- Low-voltage operation: VCC = 1.65 to 3.6 V
- High-speed operation:  $t_{pd} = 8.5 \text{ ns (max) (V}_{CC} = 3.0 \text{ to } 3.6 \text{ V)}$
- Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 3.0 \text{ V})$
- Latch-up performance: >±500 mA
- Available in JEITA SOP, TSSOP and VSSOP (US)
- Power-down protection provided on all inputs and outputs
- Pin and function compatible with the 74 series (74AC/VHC/HC/F/ALS/LS etc.) 574 type



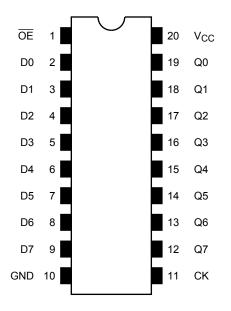
Weight

SOP20-P-300-1.27A : 0.22 g (typ.) TSSOP20-P-0044-0.65A : 0.08 g (typ.) VSSOP20-P-0030-0.50 : 0.03 g (typ.)

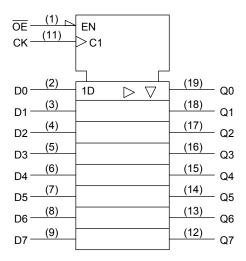
Note: The Electrical Characteristics of  $V_{CC}=1.8\pm0.15V$  is only applicable for products which manufactured from January 2009 onward.

Start of commercial production 1994-10

## Pin Assignment (top view)



## **IEC Logic Symbol**



### **Truth Table**

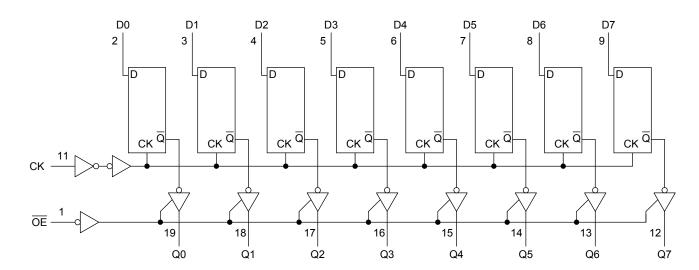
	Inputs	puts Outputs			
ŌĒ	CK	D	Outputs		
Н	X	Х	Z		
L	<b>T</b>	Х	Qn		
L		L	L		
L		Н	Н		

X: Don't care

Z: High impedance

Qn: No change

## **System Diagram**





### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Power supply voltage	$V_{CC}$	−0.5 to 7.0	V
DC input voltage	V <sub>IN</sub>	−0.5 to 7.0	V
		-0.5 to 7.0 (Note 2)	V
DC output voltage	Vout	$-0.5$ to $V_{CC}$ + 0.5 (Note 3)	
Input diode current	I <sub>IK</sub>	-50	mA
Output diode current	lok	±50 (Note 4)	mA
DC output current	lout	±50	mA
Power dissipation	P <sub>D</sub>	180	mW
DC V <sub>CC</sub> /ground current	I <sub>CC</sub> /I <sub>GND</sub>	±100	mA
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in OFF state

Note 3: High or low state. IOUT absolute maximum rating must be observed.

Note 4: Vout < GND, Vout > Vcc

## **Operating Ranges (Note 1)**

Characteristics	Symbol	Rating	Unit	
Power supply voltage	V <sub>CC</sub>	1.65 to 3.6	V	
Power supply voltage	v CC	1.5 to 3.6 (Note 2)	V	
Input voltage	V <sub>IN</sub>	0 to 5.5	V	
Output voltage	V <sub>OUT</sub>	0 to 5.5 (Note 3)	V	
Output voltage		0 to V <sub>CC</sub> (Note 4)		
Output current	I <sub>OH</sub> /I <sub>OL</sub>	±24 (Note 5)	mA	
Output current		±12 (Note 6)	ША	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dv	0 to 10 (Note 7)	ns/V	

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 2: Data retention only

Note 3: Output in OFF state

Note 4: High or low state

Note 5:  $V_{CC} = 3.0 \text{ to } 3.6 \text{ V}$ 

Note 6:  $V_{CC} = 2.7 \text{ to } 3.0 \text{ V}$ 

Note 7:  $V_{IN} = 0.8$  to 2.0 V,  $V_{CC} = 3.0$  V



## **Electrical Characteristics**

### DC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics Sym		Symbol	Test Condition			Min	Max	Unit							
					V <sub>CC</sub> (V)										
					1.65 to 2.3 2.3 to 2.7	V <sub>CC</sub> × 0.9	_								
	H-level	V <sub>IH</sub>	_	_		1.7	_								
Input voltage					2.7 to 3.6	2.0	_	V							
put voitage					1.65 to 2.3	_	$V_{CC} \times 0.1$								
	L-level	V <sub>IL</sub>	_	_	2.3 to 2.7		0.7								
					2.7 to 3.6		0.8								
				$I_{OH} = -100 \mu A$	1.65 to 3.6	V <sub>CC</sub> -0.2									
				I <sub>OH</sub> = -4 mA	1.65	1.05	_								
	H-level		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -8 mA	2.3	1.7	_	V							
	H-level	V <sub>OH</sub>		I <sub>OH</sub> = -12 mA	2.7	2.2	_								
				I <sub>OH</sub> = -18 mA	3.0	2.4	_								
				I <sub>OH</sub> = -24 mA	3.0	2.2	_								
Output voltage	L-level V		$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL} = 100 \mu A$	1.65 to 3.6	_	0.2								
				I <sub>OL</sub> = 4 mA	1.65	_	0.45								
				I <sub>OL</sub> = 8 mA	2.3	_	0.7								
		V <sub>OL</sub>		I <sub>OL</sub> = 12 mA	2.7	_	0.4								
											I <sub>OL</sub> = 16 mA	3.0	_	0.4	
				I <sub>OL</sub> = 24 mA	3.0	_	0.55								
Input leakage current		I <sub>IN</sub>	V <sub>IN</sub> = 0 to 5.5 V	V <sub>IN</sub> = 0 to 5.5 V		_	±5.0	μА							
3-state output off-state current		l <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = 0 to 5.5 V		1.65 to 3.6	_	±5.0	μА							
Power off leakage curr	Power off leakage current I <sub>OFF</sub> V <sub>IN</sub> /V <sub>OUT</sub> = 5.5 V		0	_	10.0	μА									
Outroped supply			V <sub>IN</sub> = V <sub>CC</sub> or GND		1.65 to 3.6	_	10.0								
Quiescent supply curre	erit	Icc	V <sub>IN</sub> /V <sub>OUT</sub> = 3.6 to 5.5 V		1.65 to 3.6	_	±10.0	μΑ							
Increase in I <sub>CC</sub> per inp	ut	Δl <sub>CC</sub>	$V_{IH} = V_{CC} - 0.6$	V	2.7 to 3.6	_	500								



# AC Characteristics ( $Ta = -40 \text{ to } 85^{\circ}\text{C}$ )

Characteristics	Characteristics Symbol Test Condition			Min	Max	Unit
Characteristics	Symbol	rest Condition	V <sub>CC</sub> (V)	IVIIII	IVIAX	Offic
			1.8±0.15	50	_	MHz
Maximum clock frequency	f <sub>max</sub>	Figure 1, Figure 2	2.5±0.2	100	_	
Maximum clock frequency	imax	Tigure 1, Figure 2	2.7	100	_	
			$3.3 \pm 0.3$	150		
			1.8±0.15	_	30.0	
Propagation delay time	t <sub>pLH</sub>	Figure 1, Figure 2	2.5±0.2	_	10.5	ns
(CK-Q)	t <sub>pHL</sub>	Tigure 1, Figure 2	2.7	_	9.5	113
			$3.3 \pm 0.3$	1.5	8.5	
			1.8±0.15	_	34.0	
Output enable time	t <sub>pZL</sub>	Figure 1, Figure 3	2.5±0.2	_	17.0	no
Output enable time	t <sub>pZH</sub>	rigule 1, rigule 3	2.7	_	9.5	ns
			$3.3 \pm 0.3$	1.5	8.5	
			1.8±0.15	_	28.0	
Outrout dischile time	t <sub>pLZ</sub> t <sub>pHZ</sub>	Figure 1, Figure 3	2.5±0.2	_	14.0	ns
Output disable time			2.7	_	7.0	
			$3.3 \pm 0.3$	1.5	6.5	
	t <sub>W</sub> (H)	Figure 1, Figure 2	1.8±0.15	10.0	_	ns
Minimum pulse width			2.5±0.2	5.0		
(CK)			2.7	3.3		
			$3.3 \pm 0.3$	3.3	_	
			1.8±0.15	10.0	_	ns
NA!		Figure 1, Figure 2	2.5±0.2	5.0	_	
Minimum set-up time	t <sub>s</sub>		2.7	2.5	_	
			$3.3 \pm 0.3$	2.5	_	
			1.8±0.15	1.5	_	ns
Minimum hold time	4.	Figure 1, Figure 2	2.5±0.2	1.5	_	
Minimum hold time	t <sub>h</sub>		2.7	1.5	_	
			$3.3 \pm 0.3$	1.5		
Output to output skew	t <sub>osLH</sub>	(Note)	2.7	_	_	ne
Output to output skew	t <sub>osHL</sub>	(Note)	$3.3 \pm 0.3$	_	1.0	ns

Note: Parameter guaranteed by design.

 $(t_{\text{OSLH}} = |t_{\text{pLHm}} - t_{\text{pLHn}}|, \, t_{\text{OSHL}} = |t_{\text{pHLm}} - t_{\text{pHLn}}|)$ 



### Dynamic Switching Characteristics (Ta= 25°C, input: $t_r = t_f = 2.5$ ns, $C_L = 50$ pF, $R_L = 500$ $\Omega$ )

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Quiet output maximum dynamic $V_{OL}$	V <sub>OLP</sub>	$V_{IH}=3.3\;V,\;V_{IL}=0\;V$	3.3	0.8	V
Quiet output minimum dynamic $V_{\mbox{OL}}$	V <sub>OLV</sub>	$V_{IH}=3.3\ V,\ V_{IL}=0\ V$	3.3	0.8	V

### **Capacitive Characteristics (Ta = 25°C)**

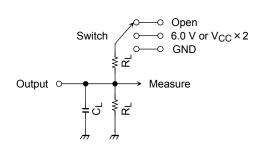
Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Тур.	Unit
Input capacitance	C <sub>IN</sub>	_	3.3	7	pF
Output capacitance	C <sub>OUT</sub>	_	3.3	8	pF
Power dissipation capacitance	C <sub>PD</sub>	$f_{IN} = 10 \text{ MHz}$ (Note)	3.3	25	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/8 \text{ (per bit)}$ 

### **AC Test Circuit**



Parameter	Switch		
t <sub>pLH</sub> , t <sub>pHL</sub>	Open		
	6.0 V	@ V <sub>CC</sub> =3.3±0.3V	
t., = t.=.		@ V <sub>CC</sub> =2.7V	
<sup>t</sup> pLZ, <sup>t</sup> pZL	V <sub>CC</sub> ×2	@ V <sub>CC</sub> =2.5±0.2V	
		@ V <sub>CC</sub> =1.8±0.15V	
t <sub>pHZ</sub> , t <sub>pZH</sub>	GND		

Figure 1

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### **AC Waveform**

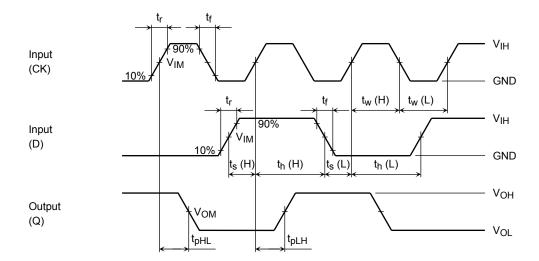


Figure 2 t<sub>pLH</sub>, t<sub>pHL</sub>, t<sub>w</sub>, t<sub>s</sub>, t<sub>h</sub>

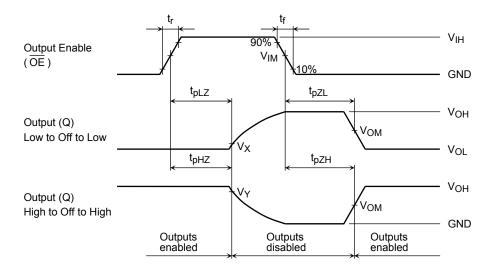


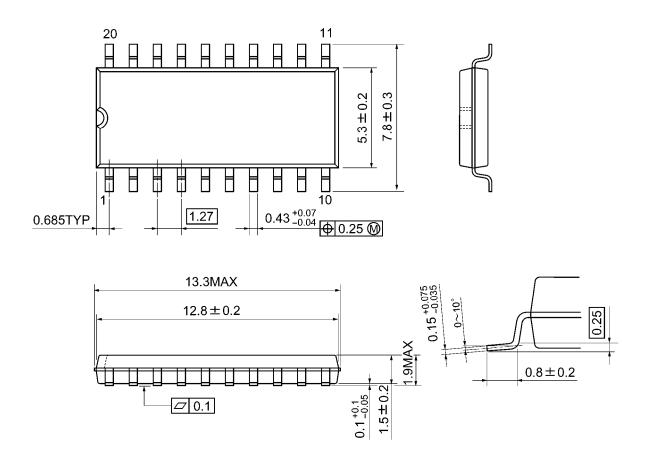
Figure 3  $t_{pLZ}$ ,  $t_{pHZ}$ ,  $t_{pZL}$ ,  $t_{pZH}$ 

		Vcc				
	Symbol	3.3 ± 0.3 V 2.7V	2.5 ± 0.2 V	1.8 ± 0.15 V		
Input	V <sub>IH</sub>	2.7V	V <sub>CC</sub>	V <sub>CC</sub>		
	$V_{IM}$	1.5V	V <sub>CC</sub> /2	V <sub>CC</sub> /2		
	t <sub>r</sub> , t <sub>f</sub>	2.5ns	2.0ns	2.0ns		
Output	V <sub>OM</sub>	1.5V	V <sub>OH</sub> /2	V <sub>OH</sub> /2		
	VX	V <sub>OL</sub> +0.3V	V <sub>OL</sub> +0.15V	V <sub>OL</sub> +0.15V		
	VY	V <sub>OH</sub> -0.3V	V <sub>OH</sub> -0.15V	V <sub>OH</sub> -0.15V		
Load	CL	50pF	30pF	30pF		
	$R_{L}$	500Ω	500Ω	1kΩ		



## **Package Dimensions**

SOP20-P-300-1.27A Unit: mm

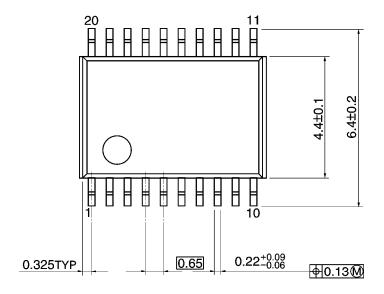


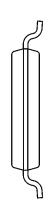
Weight: 0.22 g (typ.)

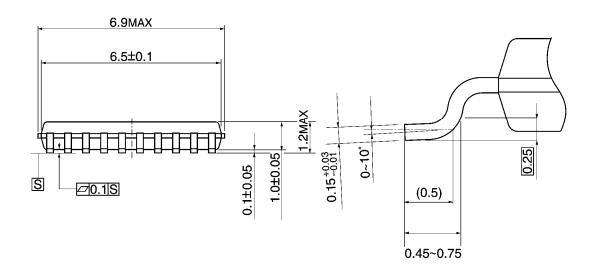
## **Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm





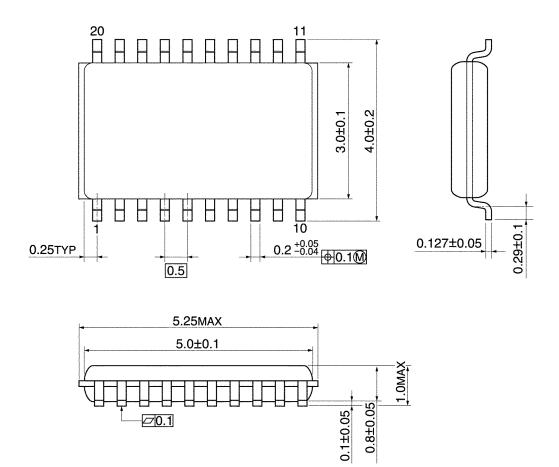


Weight: 0.08 g (typ.)



## **Package Dimensions**

VSSOP20-P-0030-0.50 Unit: mm



Weight: 0.03 g (typ.)

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